

# SSM3K344R

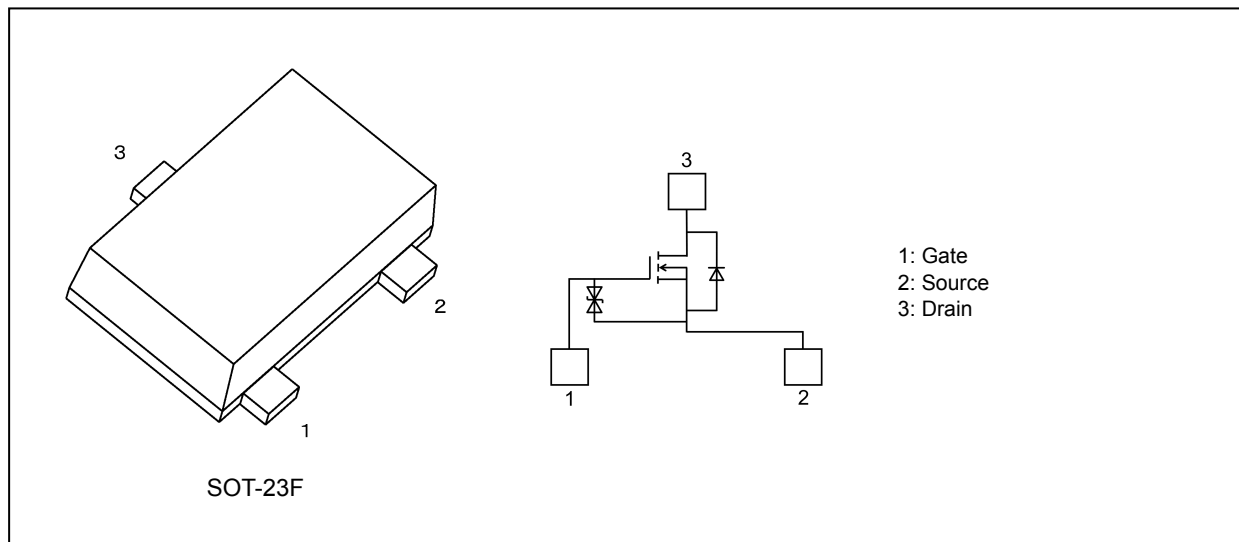
## 1. Applications

- Power Management Switches
- DC-DC Converters

## 2. Features

- (1) 1.5 V drive
- (2) Low drain-source on-resistance
  - :  $R_{DS(ON)} = 51 \text{ m}\Omega$  (Typ.) (@ $V_{GS} = 4.5 \text{ V}$ )
  - $R_{DS(ON)} = 63 \text{ m}\Omega$  (Typ.) (@ $V_{GS} = 2.5 \text{ V}$ )
  - $R_{DS(ON)} = 81 \text{ m}\Omega$  (Typ.) (@ $V_{GS} = 1.8 \text{ V}$ )
  - $R_{DS(ON)} = 102 \text{ m}\Omega$  (Typ.) (@ $V_{GS} = 1.5 \text{ V}$ )

## 3. Packaging and Pin Assignment



Start of commercial production  
2016-11

### 4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DS}$	20	V
Gate-source voltage	$V_{GS}$	$\pm 8$	
Drain current (Note 1)	$I_D$	3	A
Drain current (pulsed) (Note 1), (Note 2)	$I_{DP}$	10	
Power dissipation (Note 3)	$P_D$	1	W
Power dissipation $t = 5\text{ s}$ (Note 3)		2	
Channel temperature	$T_{ch}$	150	$^{\circ}\text{C}$
Storage temperature	$T_{stg}$	-55 to 150	

Note : Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Ensure that the channel temperature does not exceed  $150\text{ }^{\circ}\text{C}$

Note 2: pulse width  $\leq 10\text{ ms}$ , Duty  $\leq 1\%$

Note 3: Device mounted on a  $25.4\text{ mm} \times 25.4\text{ mm} \times 1.6\text{ mm}$  FR-4 glass epoxy board (Cu pad:  $645\text{ mm}^2$ )

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance,  $R_{th(ch-a)}$ , and the drain power dissipation,  $P_D$ , vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

### 5. Thermal Characteristics

Characteristics	Symbol	Max	Unit
Channel-to-ambient thermal resistance (Note 1)	$R_{th(ch-a)}$	125	$^{\circ}\text{C/W}$

Note 1: Device mounted on an  $25.4\text{ mm} \times 25.4\text{ mm} \times 1.6\text{ mm}$  FR4 glass epoxy board (Cu pad:  $645\text{ mm}^2$ )

### 6. Electrical Characteristics

#### 6.1. Static Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 1\text{ mA}$ , $V_{GS} = 0\text{ V}$	20	—	—	V
Drain-source breakdown voltage (Note 1)	$V_{(BR)DSX}$	$I_D = 1\text{ mA}$ , $V_{GS} = -5\text{ V}$	15	—	—	V
Drain cut-off current	$I_{DSS}$	$V_{DS} = 10\text{ V}$ , $V_{GS} = 0\text{ V}$	—	—	1	$\mu\text{A}$
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 8\text{ V}$ , $V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Gate threshold voltage (Note 2)	$V_{th}$	$V_{DS} = 3\text{ V}$ , $I_D = 1\text{ mA}$	0.4	—	1.0	V
Drain-source on-resistance (Note 3)	$R_{DS(ON)}$	$I_D = 0.5\text{ A}$ , $V_{GS} = 1.5\text{ V}$	—	102	232	$\text{m}\Omega$
		$I_D = 0.5\text{ A}$ , $V_{GS} = 1.8\text{ V}$	—	81	139	
		$I_D = 1.0\text{ A}$ , $V_{GS} = 2.5\text{ V}$	—	63	91	
		$I_D = 3.0\text{ A}$ , $V_{GS} = 4.5\text{ V}$	—	51	71	

Note 1: If a reverse bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

Note 2: Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current ( $I_D$ ) to below (1 mA for this device). Then, for normal switching operation,  $V_{GS(ON)}$  must be higher than  $V_{th}$ , and  $V_{GS(OFF)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ .

Take this into consideration when using the device.

Note 3: Pulse measurement.

#### 6.2. Dynamic Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 10\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$	—	153	—	pF
Reverse transfer capacitance	$C_{rss}$		—	15	—	
Output capacitance	$C_{oss}$		—	37	—	
Switching time (turn-on time)	$t_{on}$	$V_{DD} = 10\text{ V}$ , $I_D = 1.0\text{ A}$ , $V_{GS} = 0\text{ to }4.5\text{ V}$ , $R_{GS} = 50\text{ }\Omega$	—	13	—	ns
Switching time (turn-off time)	$t_{off}$		—	39	—	

#### 6.3. Switching Time Test Circuit

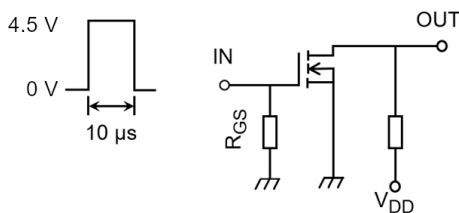


Fig. 6.3.1 Switching Time Test Circuit

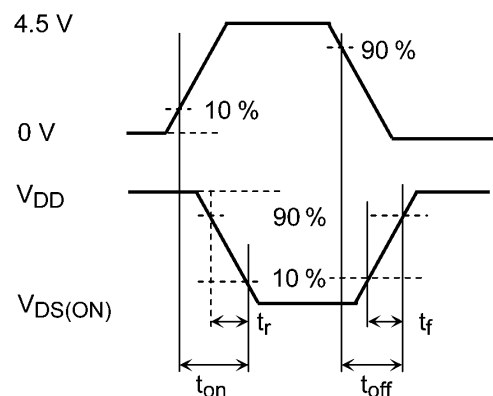


Fig. 6.3.2 Input Waveform/Output Waveform

#### 6.4. Gate Charge Characteristics (Unless otherwise specified, $T_a = 25\text{ }^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} = 10\text{ V}$ , $I_D = 3.0\text{ A}$ , $V_{GS} = 4\text{ V}$	—	2	—	nC
Gate-source charge 1	$Q_{gs1}$		—	3	—	
Gate-drain charge	$Q_{gd}$		—	0.3	—	

6.5. Source-Drain Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage (Note 1)	V <sub>DSF</sub>	I <sub>DR</sub> = 3.0 A, V <sub>GS</sub> = 0 V	—	0.8	1.2	V

Note 1: Pulse measurement.

7. Marking

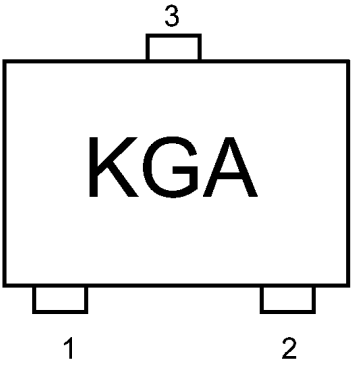


Fig. 7.1 Marking

## 8. Characteristics Curves (Note)

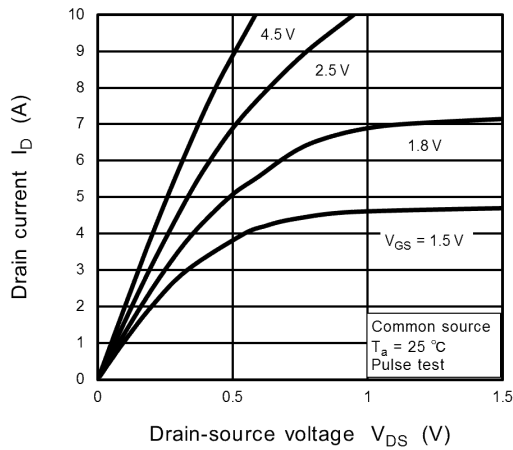


Fig. 8.1  $I_D - V_{DS}$

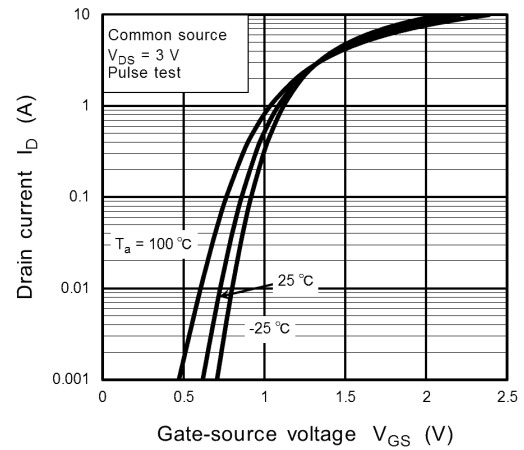


Fig. 8.2  $I_D - V_{GS}$

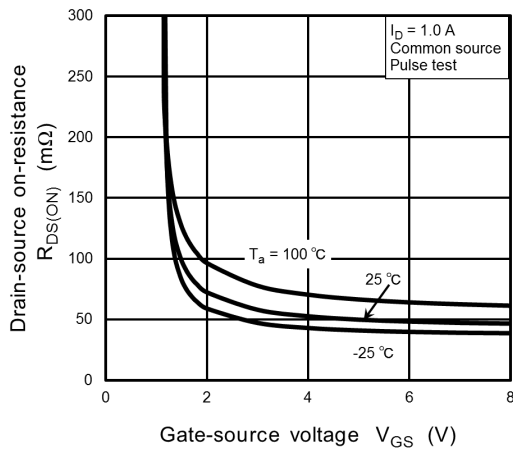


Fig. 8.3  $R_{DS(ON)} - V_{GS}$

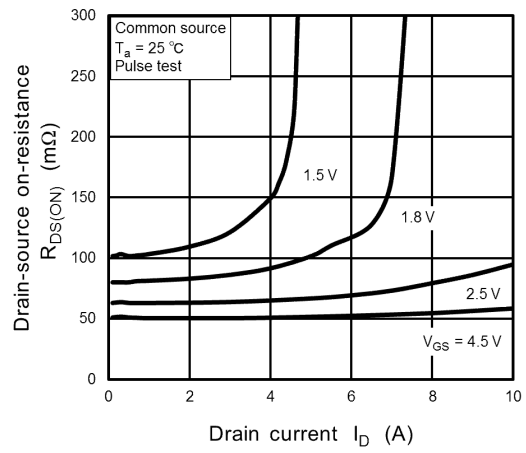


Fig. 8.4  $R_{DS(ON)} - I_D$

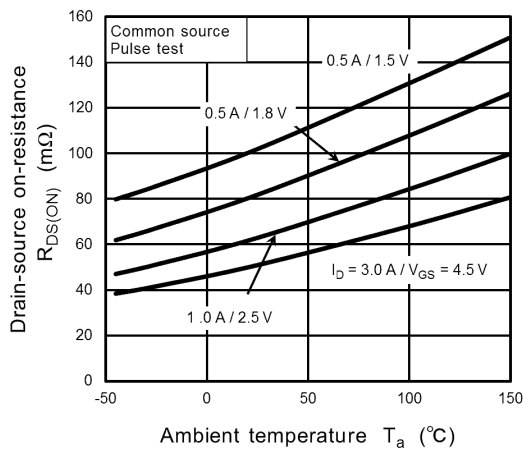


Fig. 8.5  $R_{DS(ON)} - T_a$

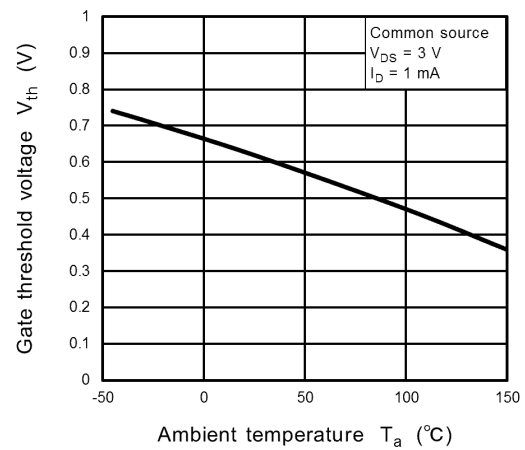


Fig. 8.6  $V_{th} - T_a$

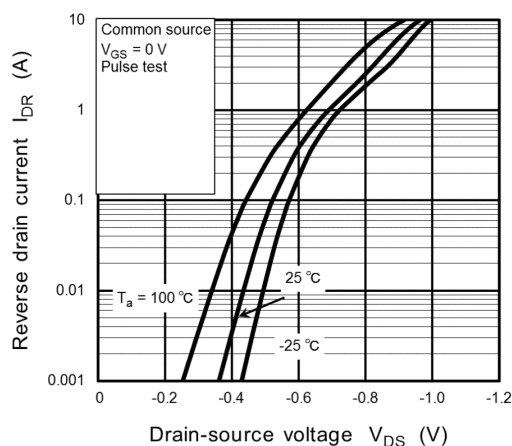


Fig. 8.7  $I_{DR} - V_{DS}$

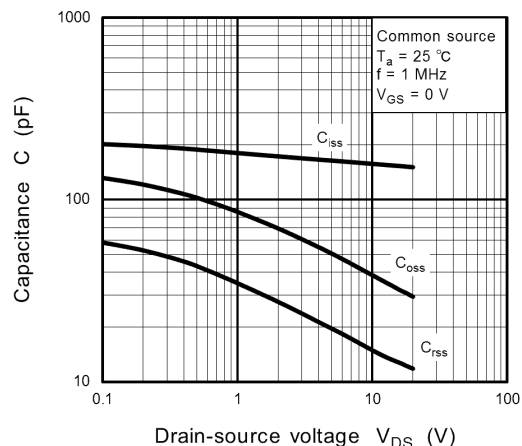


Fig. 8.8  $C - V_{DS}$

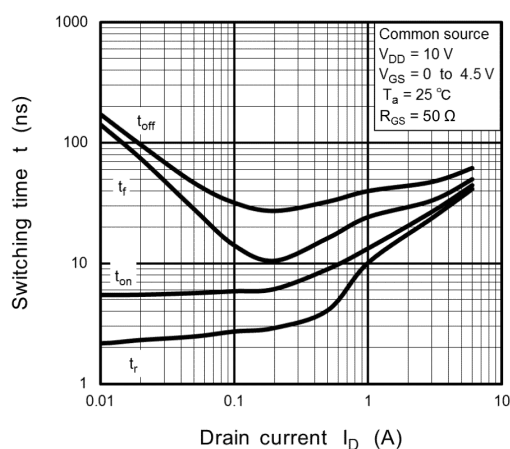


Fig. 8.9  $t - I_D$

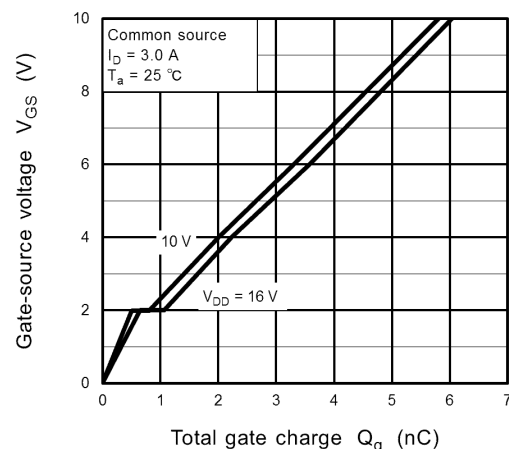


Fig. 8.10 Dynamic Input Characteristics

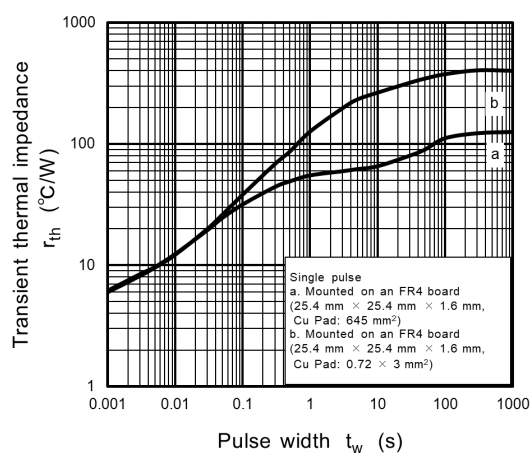


Fig. 8.11  $r_{th} - t_w$

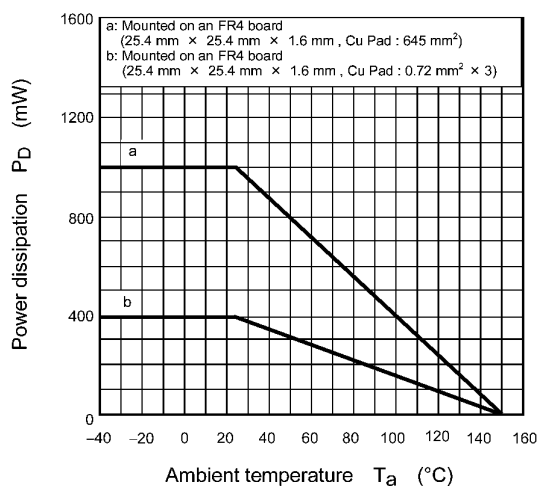


Fig. 8.12  $P_D - T_a$

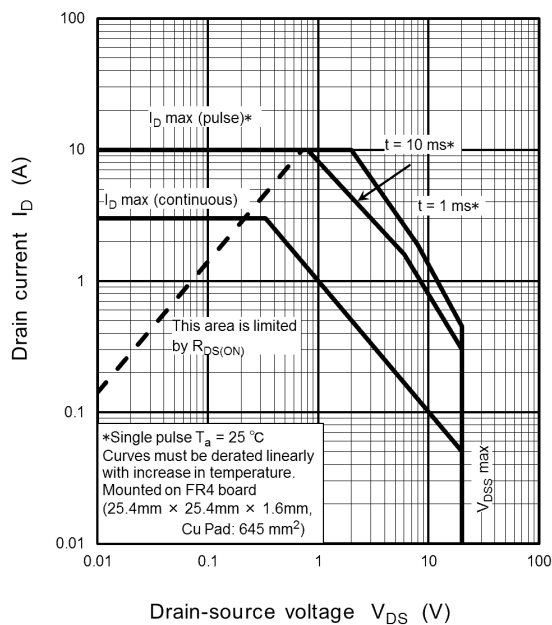
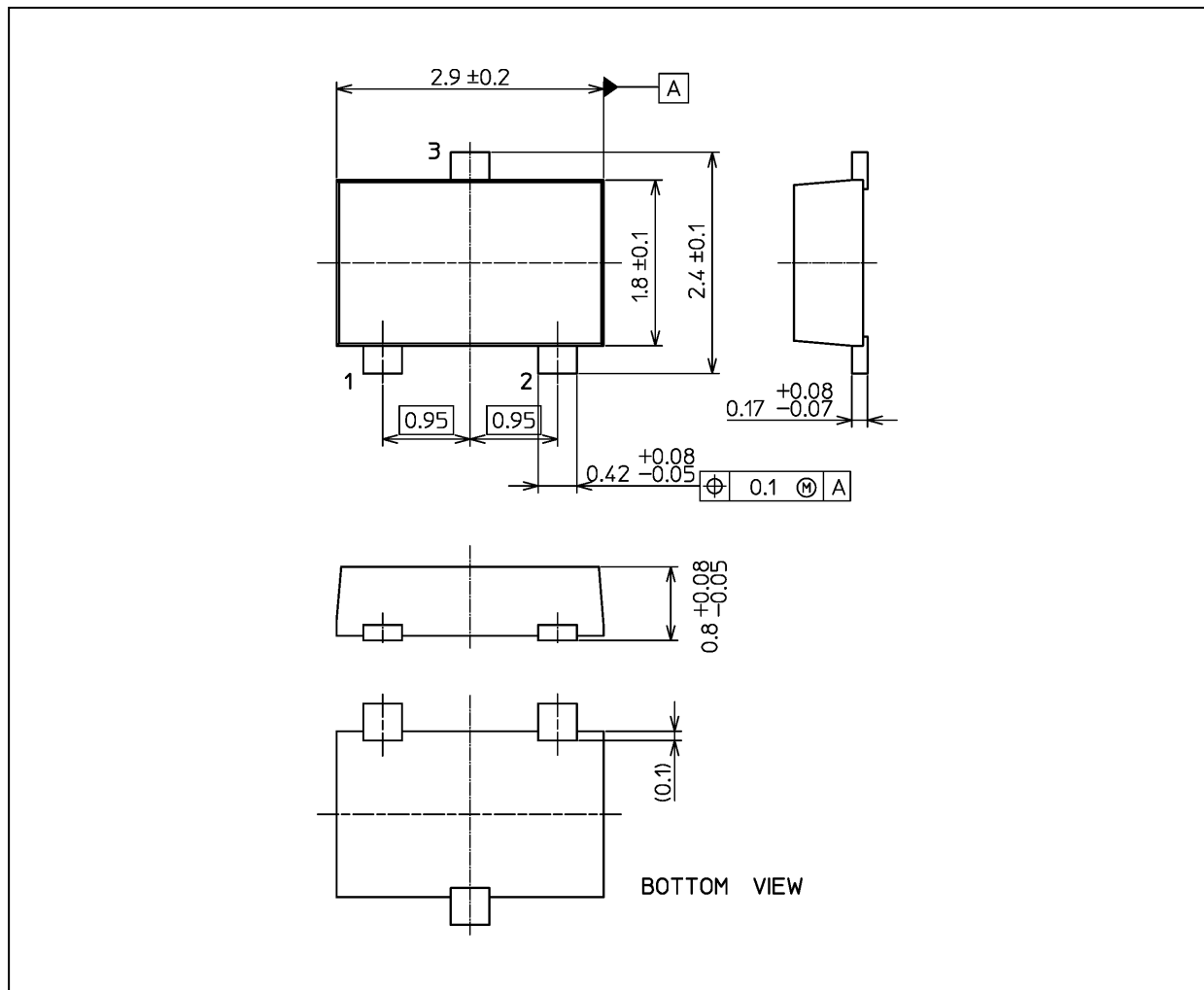


Fig. 8.13 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## Package Dimensions

Unit: mm



Weight: 0.011 g (typ.)

Package Name(s)
Nickname: SOT-23F



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